

## Application Data Sheet

### Application Information

Application Type:: Regular  
Subject Matter:: Utility  
Suggested Classification::  
Suggested Group Art Unit::  
CD-ROM or CD\_R?:: None  
Number of CD disks::  
Number of copies of CDs::  
Sequence Submission:: No  
Computer Readable Form (CRF)?:: No  
Title:: CIRCUIT BOARD ELECTRICALLY INSULATING MATERIAL, CIRCUIT BOARD AND METHOD FOR MANUFACTURING THE SAME  
Attorney Docket Number:: 10873.787USD1  
Request For Early Publication:: No  
Request For Non-Publication:: No  
Suggested Drawing Figure::  
Total Drawing Sheets:: 7  
Small Entity:: No  
Latin Name::  
Variety Denomination Name::  
Petition Included:: No  
Petition Type::  
Licensed US Govt. Agency::  
Contract or Grant Numbers::  
Secrecy Order in Parent Appl.?:: No

Initial January 9, 2004

## Applicant Information

Applicant Authority Type:: Inventor  
Primary Citizenship Country:: Japan  
Status:: Full Capacity  
Given Name:: Yoshihiro  
Middle Name::  
Family Name:: KAWAKITA  
Name Suffix::  
City of Residence:: Shijonawate-shi  
State or Province of Residence:: Osaka  
Country of Residence:: Japan  
Street of mailing address:: 10-3, Nakano-Honmachi  
City of mailing address:: Shijonawate-shi  
State or Province of mailing address:: Osaka  
Country of mailing address:: Japan  
Postal or Zip Code of mailing address:: 575-0051

Initial      January 9, 2004

## Applicant Information

Applicant Authority Type:: Inventor  
Primary Citizenship Country:: Japan  
Status:: Full Capacity  
Given Name:: Daizo  
Middle Name::  
Family Name:: ANDOH  
Name Suffix::  
City of Residence:: Katano-shi  
State or Province of Residence:: Osaka  
Country of Residence:: Japan  
Street of mailing address:: 4-9-8, Hoshidanishi  
City of mailing address:: Katano-shi  
State or Province of mailing address:: Osaka  
Country of mailing address:: Japan  
Postal or Zip Code of mailing address:: 576-0015

## Applicant Information

Applicant Authority Type:: Inventor  
Primary Citizenship Country:: Japan  
Status:: Full Capacity  
Given Name:: Fumio  
Middle Name::  
Family Name:: ECHIGO  
Name Suffix::  
City of Residence:: Osaka-shi  
State or Province of Residence:: Osaka  
Country of Residence:: Japan  
Street of mailing address:: 6-11-9-303, Toyosato, Higashiyodogawa-ku  
City of mailing address:: Osaka-shi  
State or Province of mailing address:: Osaka  
Country of mailing address:: Japan  
Postal or Zip Code of mailing address:: 533-0013

## Applicant Information

Applicant Authority Type:: Inventor  
Primary Citizenship Country:: Japan  
Status:: Full Capacity  
Given Name:: Tadashi  
Middle Name::  
Family Name:: NAKAMURA  
Name Suffix::  
City of Residence:: Suita-shi  
State or Province of Residence:: Osaka  
Country of Residence:: Japan  
Street of mailing address:: 9-25-101, Naganonishi  
City of mailing address:: Suita-shi  
State or Province of mailing address:: Osaka  
Country of mailing address:: Japan  
Postal or Zip Code of mailing address:: 565-0817

## Correspondence Information

Correspondence Customer Number:: 23552

## Representative Information

Representative Customer Number::	23552
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## Domestic Priority Information

Application::	Continuation Type::	Parent Application::	Parent Filing Date::
This application	Division of	09/956,205	September 18, 2001

## Foreign Priority Information

Country::	Application Number::	Filing Date::	Priority Claimed::
Japan	2000-282120	September 18, 2000	Yes

## Assignee Information

Assignee Name:: MATSUSHITA ELECTRIC INDUSTRIAL CO., LTD.

Street of mailing address:: 1006 Oaza Kadoma

City of mailing address:: Kadoma-shi

State or Province of mailing address:: Osaka

Country of mailing address:: Japan

Postal or Zip Code of mailing address:: 571-8501

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